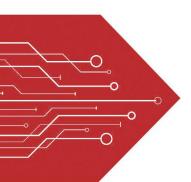
MSKSEMI















ESD

TVS

TSS

MOV

GDT

PLED

Broduct data sheet

LM393



GENERAL DESCRIPTION

LM393 是一款开漏输出的双路电压比较器,可以单电源或双电源供电。具有良好的温度稳定性,和输 出短路保护的特点。可以直接使用数字系统中的标准 5V 电源供电,而无需增加额外的供电电源。

FEATURES

- 单电源电压范围: 2V~32V
- 低输出饱和电压: 典型值 0.1V @ I₀₁=4mA
- 低功耗: 典型值 0.6mA @ VCC=5V
- 低输入失调电压:典型值±1mV

- 双电源电压范围: ±16V
- 差分输入电压范围: ±VCC
- 开漏输出
- 封装形式: DIP8、SOP8

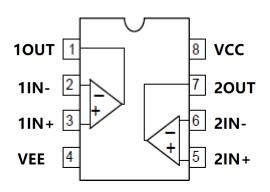
APPLICATION

- 电压鉴幅电路
- 其它应用领域

● 电压变换电路

PIN CONFIGURATION

DIP8/SOP8 管脚序号	管脚定义	功能说明
1	10UT1	第1路输出
2	1IN-	第1路负输入
3	1IN+	第1路正输入
4	VEE	负电源
5	2IN+	第2路正输入
6	2IN-	第2路负输入
7	20UT	第2路输出
8	VCC	正电源



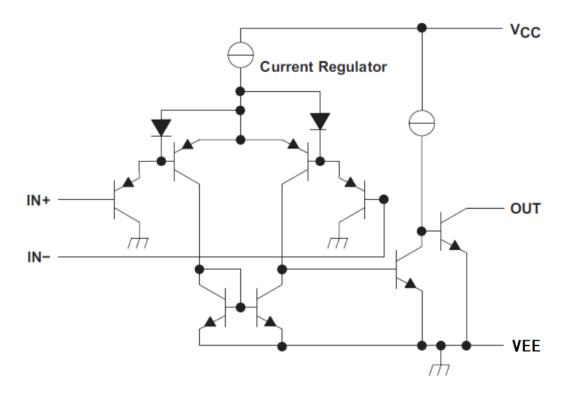


极限参数

项目	符号	极限值 ⑴	单位
单电源供电电压	V_{CC}	36	V
双电源供电电压	Vs	±18	V
差分输入电压 (2)	$ m V_{IDR}$	±18	V
共模输入电压	$ m V_{ICR}$	-0.3∼VCC	V
输出短路时间	${ m t_{sc}}$	连续	
耗散功率	P_{D}	500	mW
工作温度	T_{A}	0-70	$^{\circ}$
储存温度	T_{s}	-65-150	${\mathbb C}$
焊接温度	$T_{\mathtt{W}}$	260, 10s	$^{\circ}$

- 注: (1) 极限值是指无论在任何条件下都不能超过的极限值。如果达到此极限值,将有可能造成产品劣化等物理性损 伤;同时在接近极限参数下,不能保证芯片可以正常工作。
 - (2) 指IN+与IN-端之间的电压差。

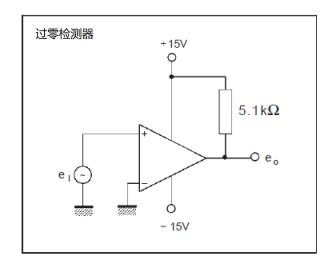
等效原理图

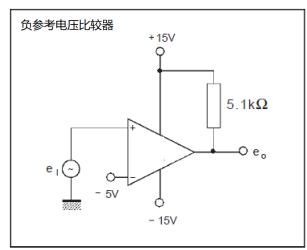


直流电学特性 (T_A=25℃, VCC=5V, VEE=GND 除非特别指定)

项目	符号	测试条件	最小值	典型值	最大值	单位
输入失调电压	V_{10}	VCC=5V to 30V, $V_{IC}=V_{ICR}$ (Min), $V_0=1.4V$	_	1	_	mV
输入失调电流	I_{10}	V ₀ =1.4V	_	5	50	nA
偏置电流	${ m I}_{ exttt{BIAS}}$	$V_0 = 1.4V$	_	100	500	nA
大信号电压增益	A_{VD}	VCC=15V, V_0 =1V to 11V, RL =15k Ω	_	200	_	V/mV
输入共模电压	$V_{\rm ICR}$	VCC=5V to 30V	0	-	VCC-1.5V	V
输入差分电压	V_{ID}	VCC=5V to 30V	0	-	VCC-1.5V	V
输出灌电流	${ m I}_{ m OL}$	V _{ID} =-1V, V ₀ =1. 5V	_	34	_	mA
输出低电平电压	V_{OL}	V_{ID} =-1V, I_{OL} =4mA	-	0.1	0.4	V
输出漏电流	${ m I}_{ m OH}$	V _{1D} =1V, V ₀ =VCC=30V	_	_	1	uA
电源工作电流 I _{cc}	т	VCC=5V, No load	_	0.6	2	mA
	1cc	VCC=32V, No load	_	1.0	3	mA
单电源工作电压	VCC	VEE=OV (GND)	2	_	32	V
双电源工作电压	VS	VCC+, VEE-	-16	=	+16	V

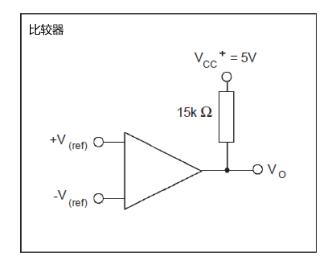
典型应用(仅做参考)

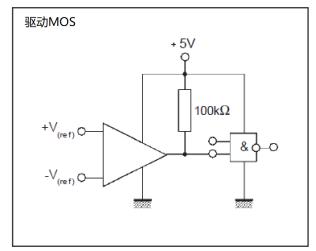


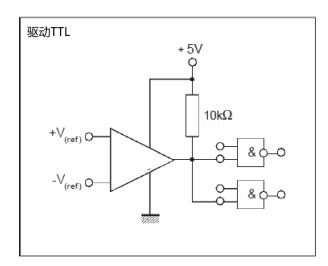


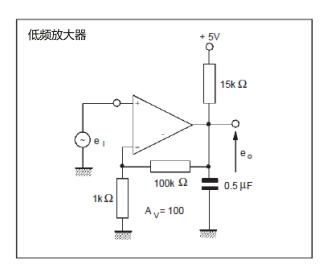


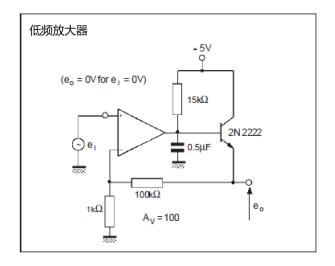


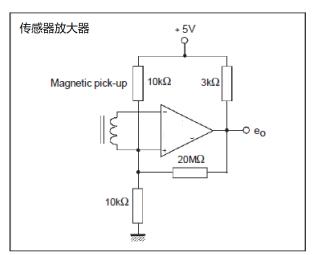






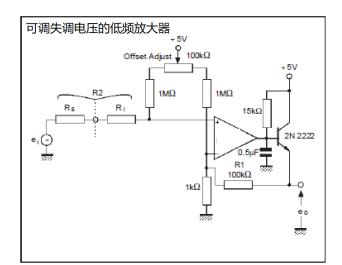


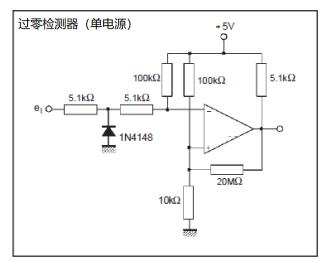


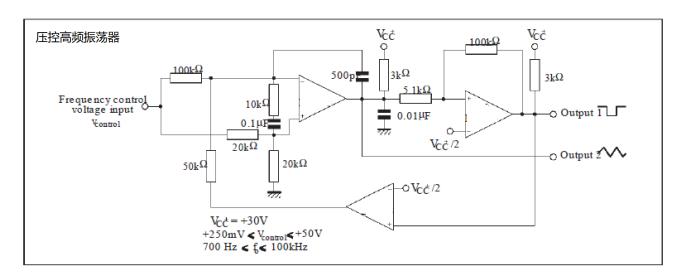


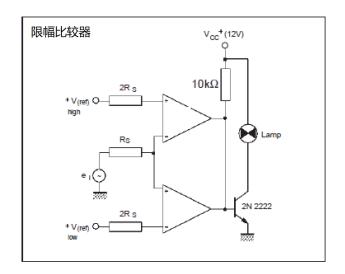


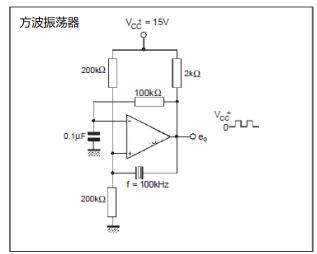








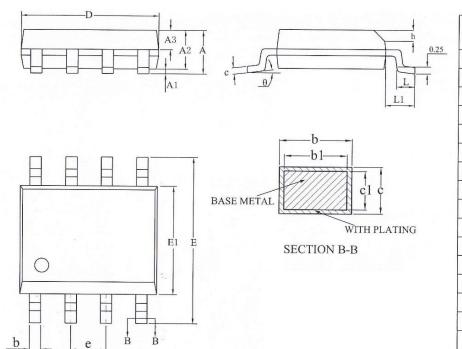








PACKAGE MECHANICAL DATA



SYMBOL	MILLIMETER		
SYMBOL	MIN	NOM	MAX
A	_	_	1.75
A1	0.10	_	0.225
A2	1.30	1.40	1.50
A3	0.60	0.65	0.70
b	0.39	_	0.47
b1	0.38	0.41	0.44
С	0.20		0.24
cl	0.19	0.20	0.21
D	4.80	4.90	5.00
Е	5.80	6.00	6.20
E1	3.80	3.90	4.00
e	1.27BSC		
h	0.25	_	0.50
L	0.50		0.80
Ll	1.05REF		
θ	0		8°

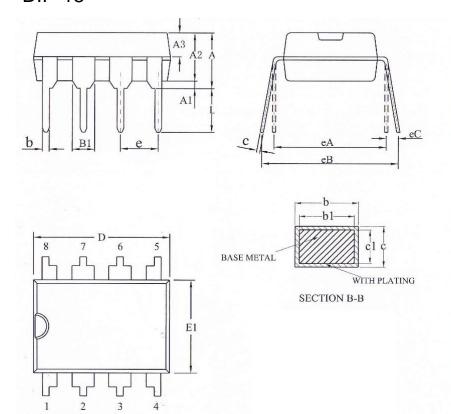
REEL SPECIFICATION

P/N	PKG	QTY
LM393	SOP-8	3000



PACKAGE MECHANICAL DATA

DIP-18



SYMBOL	MILLIMETER		
SYMBOL	MIN	NOM	MAX
A	3.60	3.80	4.00
A1	0.51	_	_
A2	3.20	3.30	3.40
A3	1.55	1.60	1.65
b	0.44	_	0.52
b1	0.43	0.46	0.49
В1	1	.52REF	7
c	0.25	_	0.29
cl	0.24	0.25	0.26
D	9.15	9.25	9.35
E1	6.25	6.35	6.45
е	2.54BSC		
eA	7.62REF		
eB	7.62	_	9.30
еC	0	_	0.84
L	3.00	_	_

REEL SPECIFICATION

P/N	PKG	QTY
LM393	DIP-18	50







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